

Notice of References Cited	Application/Control No. 10/632,700	Applicant(s)/Patent Under Reexamination KANG ET AL.	
	Examiner Mai-Huong Tran	Art Unit 2818	Page 1 of 1

U.S. PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
	A	US-6,552,426	04-2003	Ishio et al.	257/692
	B	US-6,706,557	03-2004	Koopmans, Michel	438/109
	C	US-6,333,562	12-2001	Lin, Chun Hung	257/777
	D	US-			
	E	US-			
	F	US-			
	G	US-			
	H	US-			
	I	US-			
	J	US-			
	K	US-			
	L	US-			
	M	US-			

FOREIGN PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Country	Name	Classification
	N					
	O					
	P					
	Q					
	R					
	S					
	T					

NON-PATENT DOCUMENTS

*		Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages)
	U	Shim et al., Multi-chip Package (MCP) with Spacer, Pub. Date Feb. 27, 2003, Pub. No. US 2003/0038374 A1, page 2.
	V	
	W	
	X	

*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)
Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.